

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	"20030228718"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/04 15:04
L2	421	(dielectric insulat\$3) and (substrate wafer) and (polymer) and ((source near contact) (drain near contact)) and (organic near3 layer).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/04 15:53
L3	55	(dielectric insulat\$3) and (substrate wafer) and (polymer) and ((source near contact) (drain near contact)) and (organic near3 layer) and ((field-effect) (fet)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/04 15:54
L4	13	(dielectric insulat\$3) and (substrate wafer) and (polymer) and ((source near contact) (drain near contact)) and (atmosphere) and (organic near3 layer) and ((field-effect) (fet)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/04 15:55
L5	190	(dielectric insulat\$3) and (substrate wafer) and (polymer) and ((source near contact) (drain near contact)) and (atmosphere) and (organic near3 layer) and ((field-effect) (fet))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/04 15:56
L6	0	5 and ((source near contact) (drain near contact)) with (atmosphere)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/04 15:58
L7	7	5 and ((source near contact) (drain near contact) (polymer)) with (atmosphere)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/04 15:58